

Atty Docket No.: JCLA6968

Serial N .: 09/838,752

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In Re Application of:

Jian-Cheng CHEN et al.

Serial No.: 09/838,752

Filed: April 19, 2001

For: Package of a chip with beveled  
edges

Examiner: CRUZ, Lourdes C.

Art Unit: 2827

Docket No.: JCLA6968

No fee is believed to be due. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-0710 (Order No. JCLA6968).

**AMENDMENT AND RESPONSE TO FIRST OFFICE ACTION****FAX RECEIVED**

**BOX Non-Amendment**  
Commissioner of Patents and Trademarks  
Washington, DC 20231

NOV 18 2002

**TECHNOLOGY CENTER 2800**

Sir:

The Office Action dated August 26, 2002 has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.

**In The Claims**

Please cancel claims 1-8 without prejudice or disclaimer, and further amend claims 9 and 14 as follows.

9. (Once amended) A package of a semiconductor device, the package comprising:  
a carrier, having a die pad and a plurality of leads;

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